



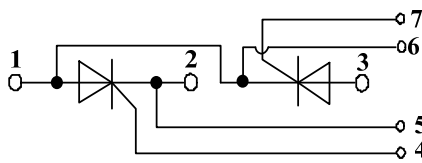
Thyristor Modules

V_{RRM} / V_{DRM} 800 to 1800V
I_{TAV} 40A

Applications

- Power Converters
- Lighting Control
- DC Motor Control and Drives
- Heat and temperature control

Circuit



Features

- International standard package
- High Surge Capability
- Glass passivated chip
- Simple Mounting
- Heat transfer through aluminum oxide DBC ceramic isolated metal baseplate
- UL recognized applied for file no. E230084

Module Type

TYPE	V _{RRM}	V _{RSM}
MT40C08T1	800V	900V
MT40C12T1	1200V	1300V
MT40C16T1	1600V	1700V
MT40C18T1	1800V	1900V

Maximum Ratings

Symbol	Conditions	Values	Units
I _{TAV}	Sine 180°; T _c =85	40	A
I _{TSM}	T _{VJ} =45 t=10ms, sine T _{VJ} =125 t=10ms, sine	1000 850	A
i ² t	T _{VJ} =45 t=10ms, sine T _{VJ} =125 t=10ms, sine	5000 3600	A ² s
Visol	a.c.50HZ;r.m.s.;1min	3000	V
T _{vj}		-40 to 125	
T _{stg}		-40 to 125	
Mt	To terminals(M5)	3 15%	Nm
Ms	To heatsink(M6)	5 15%	Nm
di/dt	T _{VJ} = T _{VJM} , 2/3V _{DRM} ,I _G =500mA Tr<0.5us,tp>6us	150	A/us
dv/dt	T _J = T _{VJM} ,2/3V _{DRM} linear voltage rise	1000	V/us
a	Maximum allowable acceleration	50	m/s ²
Weight	Module(Approximately)	100	g

Thermal Characteristics

Symbol	Conditions	Values	Units
R _{th(j-c)}	Cont.;per thyristor / per module	0.65/0.33	/W
R _{th(c-s)}	per thyristor / per module	0.2/0.1	/W



Electrical Characteristics

Symbol	Conditions	Values			Units
		Min.	Typ.	Max.	
V_{TM}	$T=25$ $I_{TM}=200A$			1.95	V
I_{RRM}/I_{DRM}	$T_{VJ}=T_{VJM}$, $V_R=V_{RRM}$, $V_D=V_{DRM}$			15	mA
V_{TO}	For power-loss calculations only ($T_{VJ}=125$)			1.0	V
r_T	$T_{VJ}=T_{VJM}$			4.5	m
V_{GT}	$T_{VJ}=25$, $V_D=6V$			2.5	V
I_{GT}	$T_{VJ}=25$, $V_D=6V$			150	mA
V_{GD}	$T_{VJ}=125$, $V_D=2/3V_{DRM}$			0.25	V
I_{GD}	$T_{VJ}=125$, $V_D=2/3V_{DRM}$			6	mA
I_L	$T_{VJ}=25$, $R_G=33$		300	600	mA
I_H	$T_{VJ}=25$, $V_D=6V$		150	250	mA
tgδ	$T_{VJ}=25$, $I_G=1A$, $di_G/dt=1A/us$	1			us
tq	$T_{VJ}=T_{VJM}$	80			us

Performance Curves

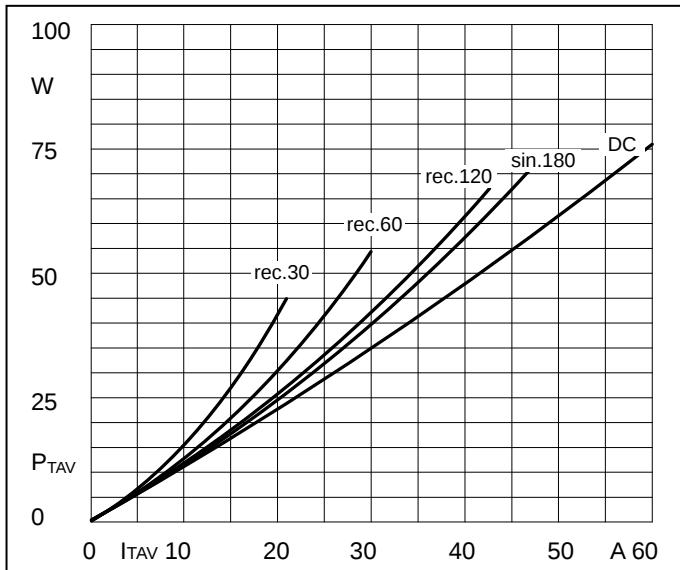


Fig1. Power dissipation

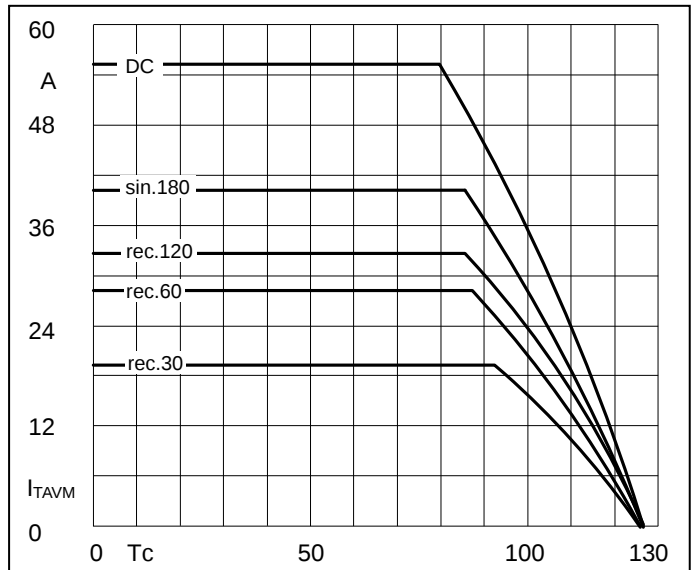


Fig2. Forward Current Derating Curve

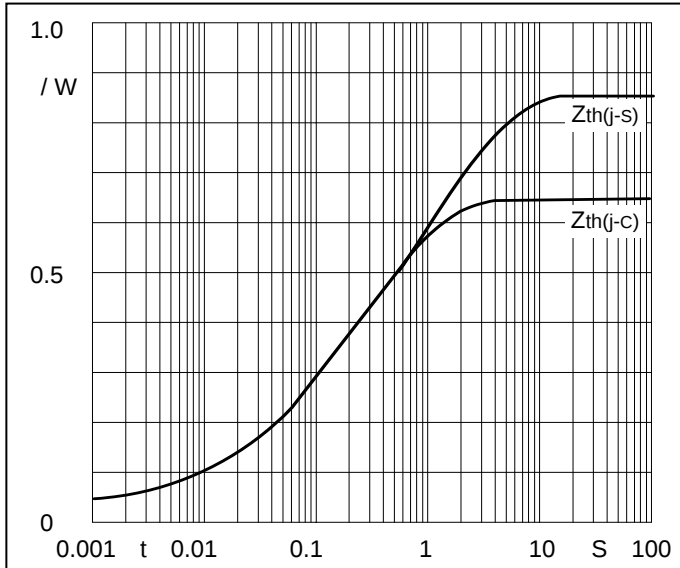


Fig3. Transient thermal impedance

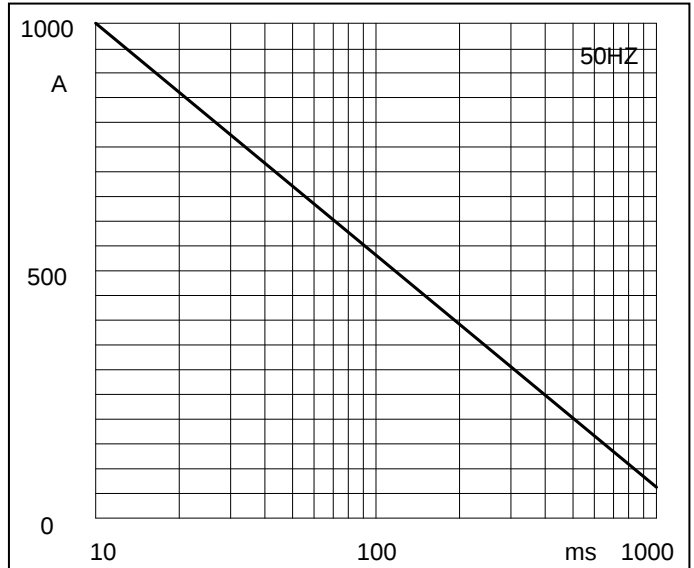


Fig4. Max Non-Repetitive Forward Surge Current

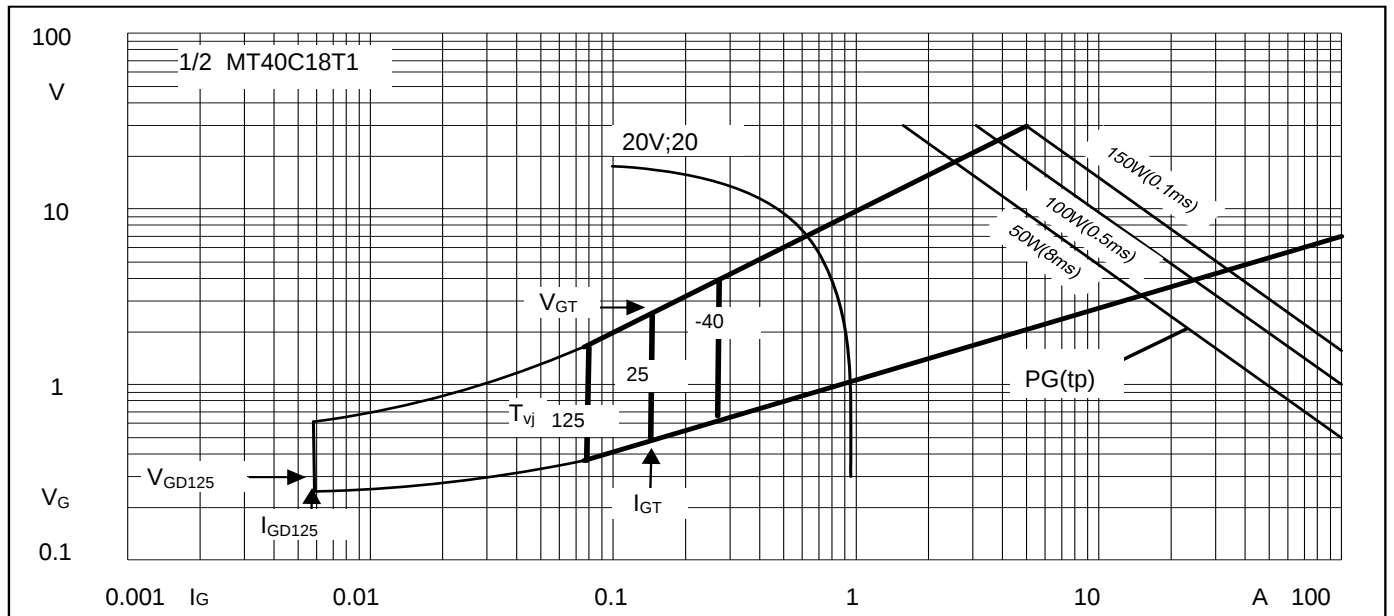
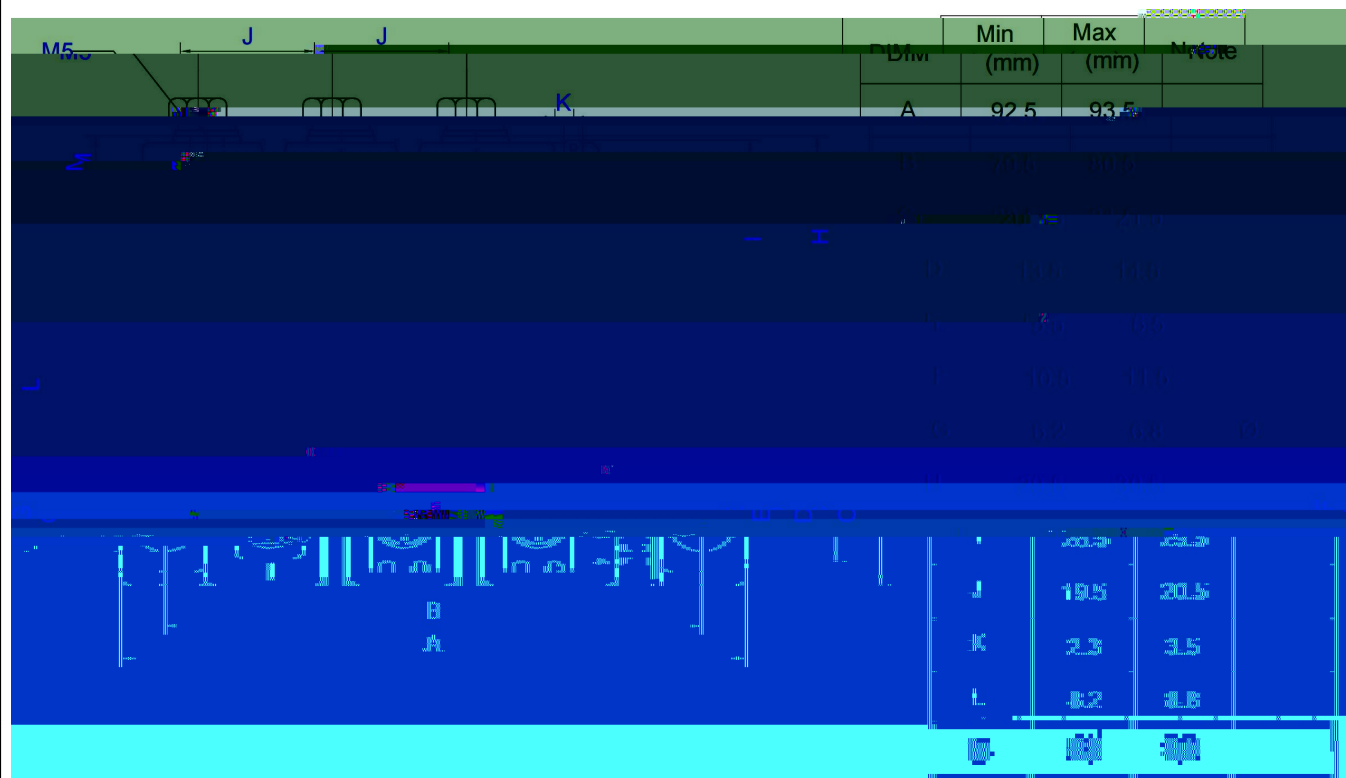


Fig5. Gate trigger Characteristics



Package Outline Information

CASE: T1



Packing Standard

Item	Length: A (mm)	Width: B (mm)	Height: C (mm)	Quantity (PCS)
Inner Box	2	25	4	1
Outer Carton	5 5		2 0	1



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